

**ROHM** BA5406 **PDF**

深圳创唯电子有限公司

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# Class-AB Speaker Amplifiers

# 5W+5W

# Stereo Speaker Amplifiers


**BA5406,BA5417**

No.13077EDT02

## ●Description

The BA5406/BA5417 is a dual OTL monolithic power IC with two built-in, high output speaker amplifier circuits. High output of 5W×2 can be produced when  $V_{CC}=12\text{ V}$  and  $R_L=3\Omega$ , and 2.8 W×2 when  $V_{CC}=9\text{ V}$  and  $R_L=3\Omega$ . The BA5406, which uses a high allowable power dissipation package, has a simple heatsink design. The BA5417 not only exceeds basic characteristics, but also has a built-in soft clip circuit, thermal shutdown and standby circuits.

## ●Features

**BA5406**

- 1) Good low voltage characteristics (Operation from  $V_{CC}=5\text{ V}$ )
- 2) Ripple filter (6pin) also can be used as muting pin (Make 6pin GND potential)
- 3) Small thermal resistance package and simple heatsink design

**BA5417**

- 1) Small pop noise when standby switches ON/OFF
- 2) Built-in circuit to prevent ripple addition when motor starts
- 3) Built-in thermal shutdown circuit
- 4) Built-in standby switch circuit
- 5) Built-in soft clip circuit

## ●Applications

Stereo radio cassette players, mini-audio systems, LCD TVs, etc.

## ●Line up matrix

Part No.	BA5406	BA5417	Units
Supply voltage	5 ~ 15	6 ~ 15	V
Power dissipation	20	15	W
Quiescent current	40	22	mA
Standby current	—	0	$\mu\text{A}$
Closed loop voltage gain	46	45	dB
Output noise voltage	0.6	0.3	mVrms
Total harmonic distortion	0.3	0.1	%
Ripple rejection	—	55	dB
Package	SIP-M12	HSIP15	—

**●Absolute maximum ratings (Ta=25°C)**

Parameter	Symbol	Ratings		Unit
		BA5406	BA5417	
Supply voltage	V <sub>CC</sub>	18 <sup>*1</sup>	20 <sup>*1</sup>	V
Power dissipation	P <sub>d</sub>	20 <sup>*2</sup>	15 <sup>*3</sup>	W
Operating temperature	T <sub>opr</sub>	-20 ~ +75	-20 ~ +75	°C
Storage temperature	T <sub>stg</sub>	-30 ~ +125	-55 ~ +150	°C

\*1 When no signal

\*2 Back metal temperature 75°C

\*3 Ta=75°C (Using infinite heatsink)

**●Operating range (Ta=25°C)**

Parameter	Symbol	Ratings		Unit
		BA5406	BA5417	
Supply voltage	V <sub>CC</sub>	5.0 ~ 15.0	6.0 ~ 15.0	V

**●Electrical characteristics** (BA5406 : Unless otherwise noted, Ta=25°C, V<sub>CC</sub>=12V)  
 (BA5417 : Unless otherwise noted, Ta=25°C, V<sub>CC</sub>=9V)

Parameter		Symbol	Limits		Unit.	Conditions
			BA5406	BA5417		
Quiescent current		I <sub>O</sub>	40	22	mA	V <sub>IN</sub> =0Vms
Rated output power		P <sub>OUT</sub>	5.0	5.0	W	THD=10%, V <sub>CC</sub> =12V, R <sub>L</sub> =3Ω
Closed loop voltage gain		G <sub>VC</sub>	46	45	dB	—
Output noise voltage		V <sub>NO</sub>	0.6	0.3	mVrms	R <sub>g</sub> =10kΩ, DIN-Audio
Total harmonic distortion		THD	0.3	0.1	%	P <sub>OUT</sub> =0.5W, f=1kHz
Ripple rejection		RR	—	55	dB	f <sub>RR</sub> =100Hz, V <sub>RR</sub> =-10dBm
Crosstalk		CT	—	65	dB	V <sub>O</sub> =0dBm
Standby current		I <sub>OFF</sub>	—	0	μA	—
Standby pin input current		I <sub>SIN</sub>	—	0.15	mA	V <sub>STBY</sub> =V <sub>CC</sub>
Standby pin control voltage	Activated	V <sub>STH</sub>	—	3.5 ~ V <sub>CC</sub>	V	—
	Not Activated	V <sub>STL</sub>	—	0 ~ 1.2	V	—

\* Note: This IC is not designed to be radiation-resistant.

●Block diagram

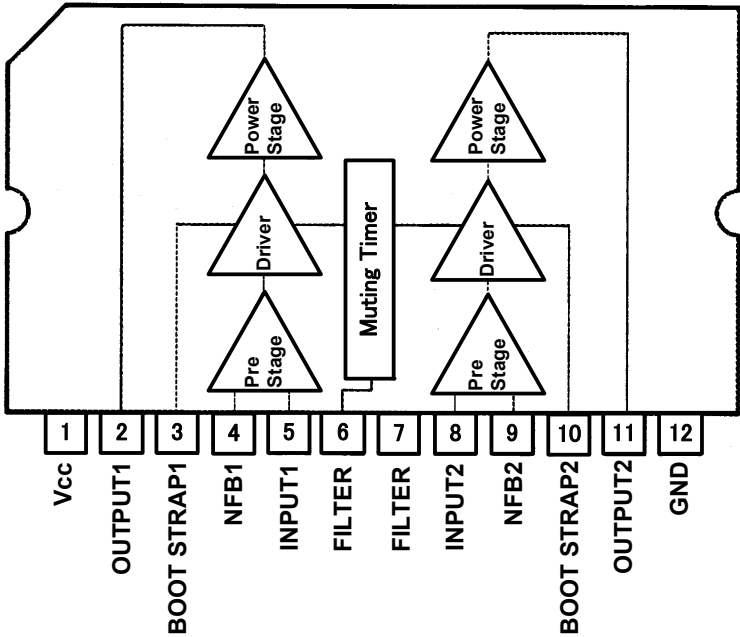


Fig.1 BA5406

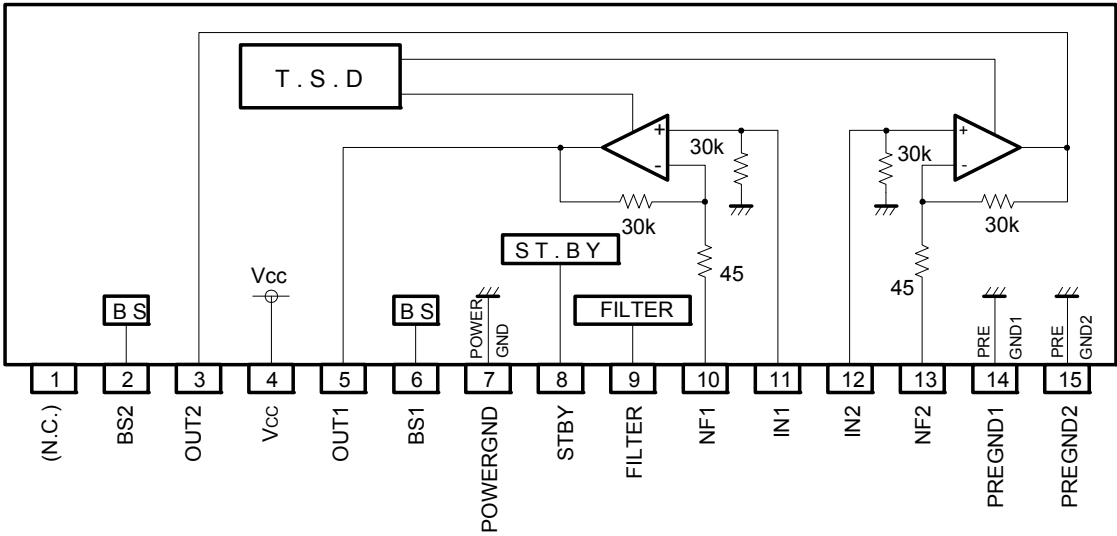


Fig.2 BA5417

## ● Measurement circuit

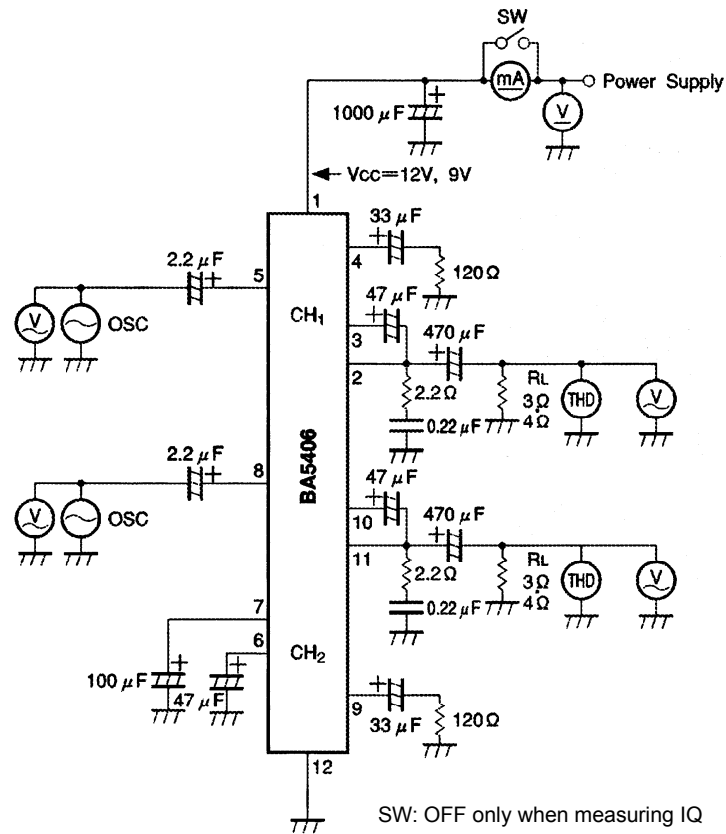


Fig.3 BA5406

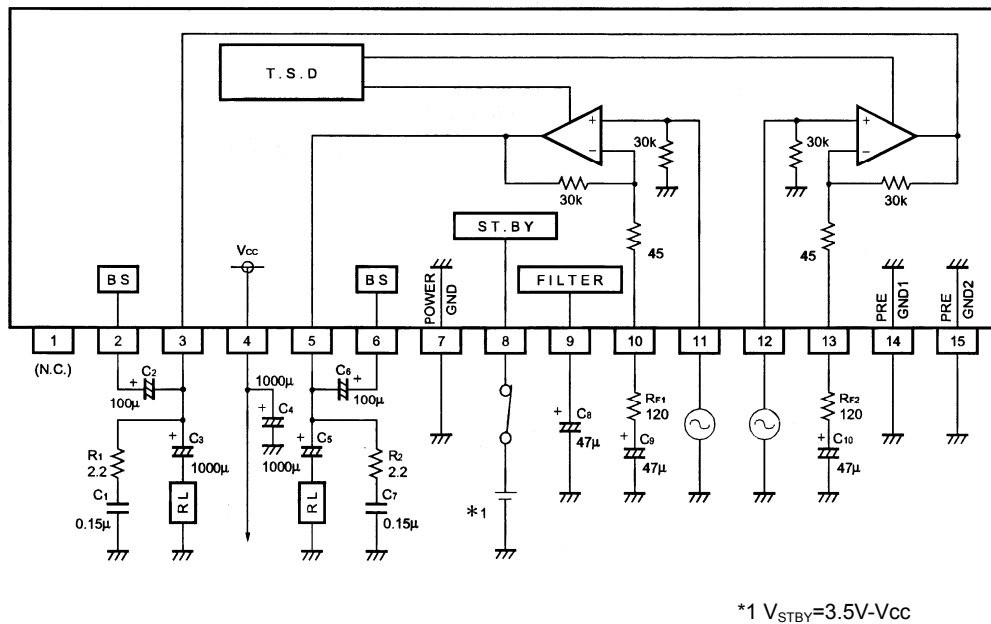


Fig.4 BA5417

●Application circuit  
BA5406

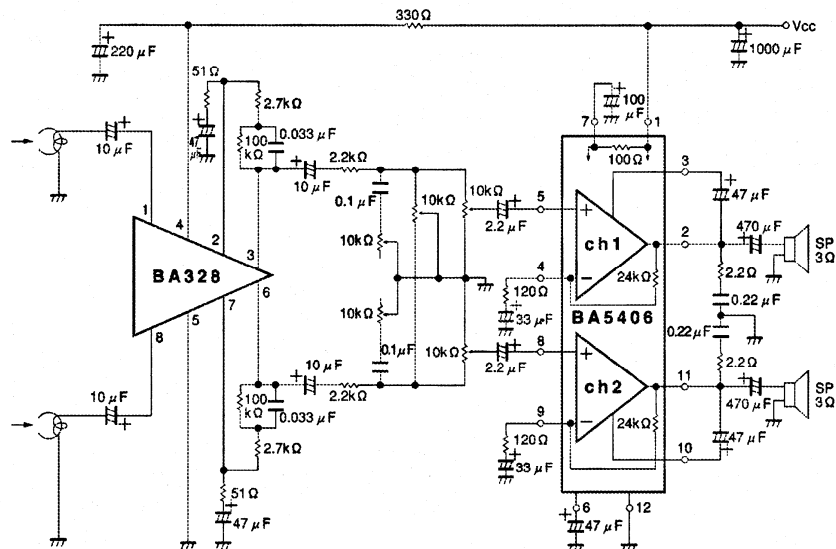


Fig.5

BA5417  
OTL mode circuit

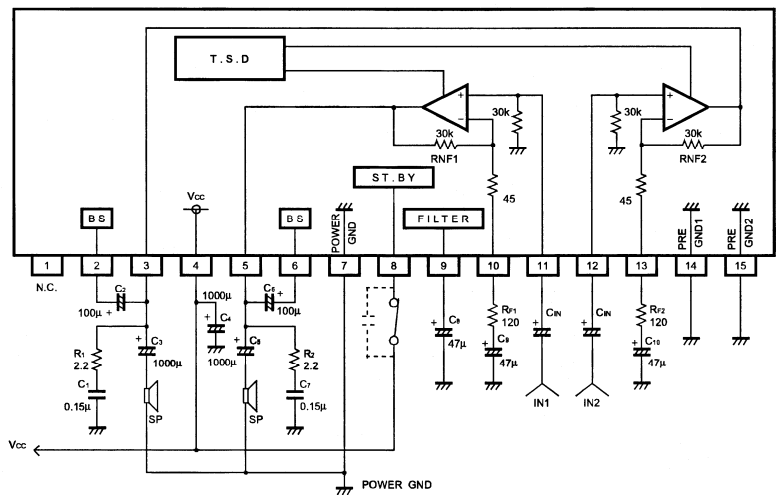


Fig.6

BTL mode circuit

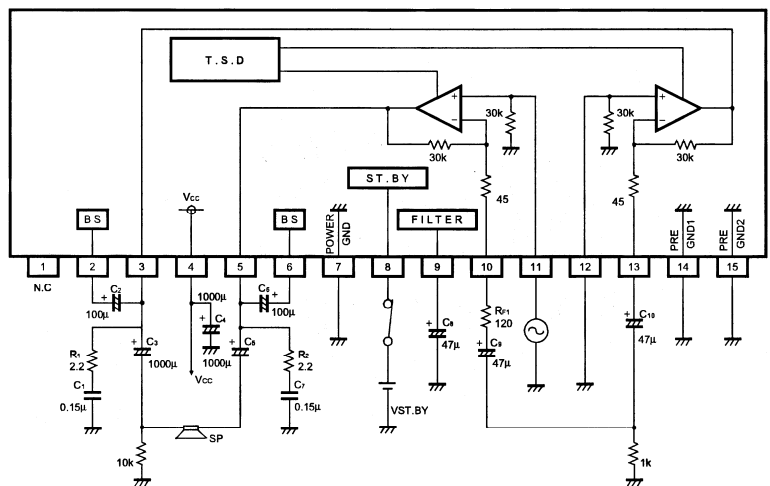


Fig.7

## ●Reference data

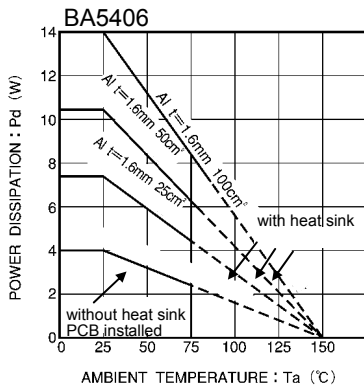


Fig.8 Thermal derating curve

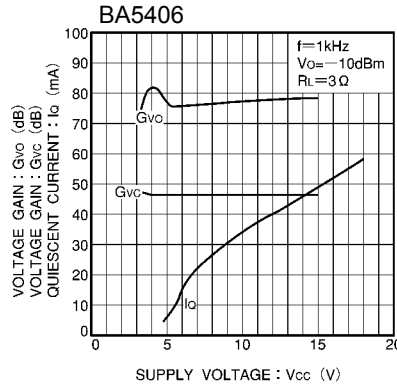


Fig.9 Quiescent current and voltage gain vs Supply voltage

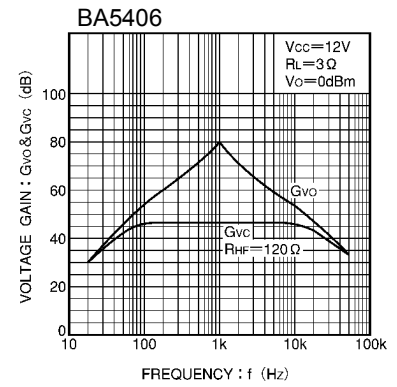


Fig.10 Voltage gain vs frequency

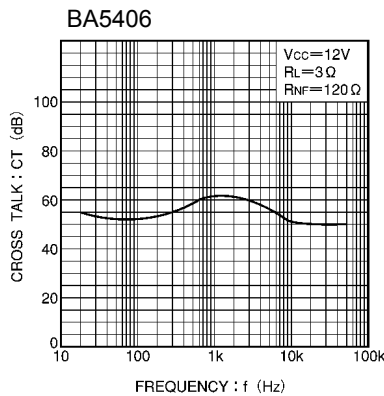


Fig.11 Crosstalk vs frequency

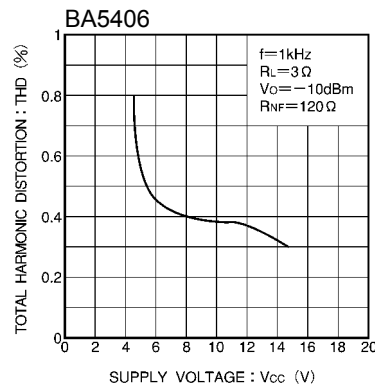


Fig.12 Distortion vs power supply voltage

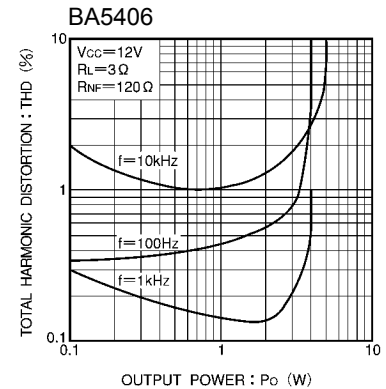


Fig.13 Distortion vs Output power

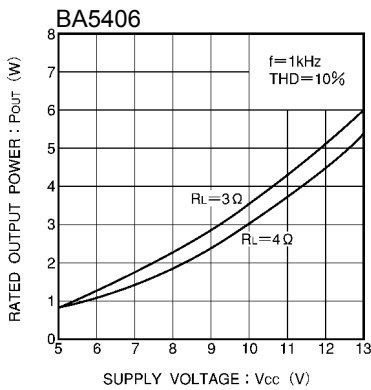


Fig.14 Output power vs power supply voltage

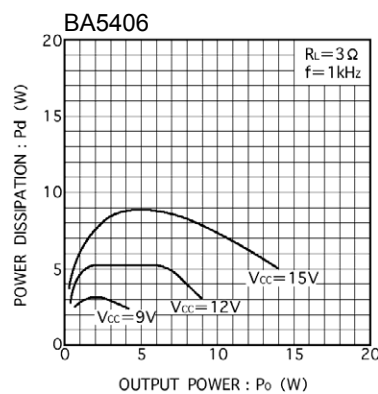


Fig.15 Power dissipation vs Output power(1)

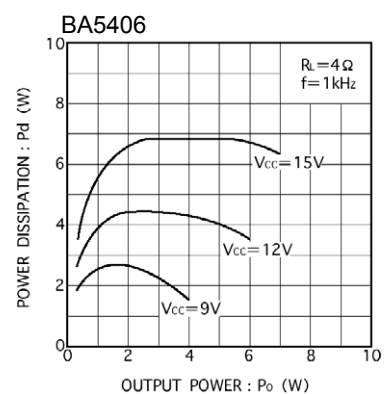


Fig.16 Power dissipation vs Output power(2)

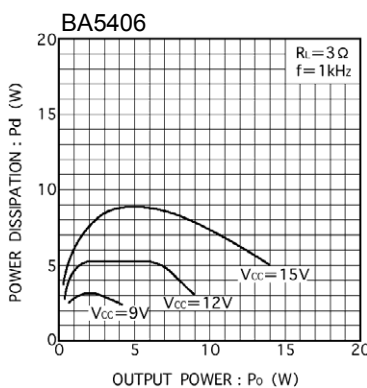


Fig.17 Power dissipation vs Output power(3)

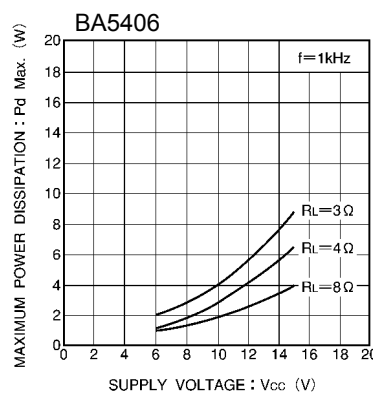


Fig.18 Maximum power dissipation vs Supply voltage

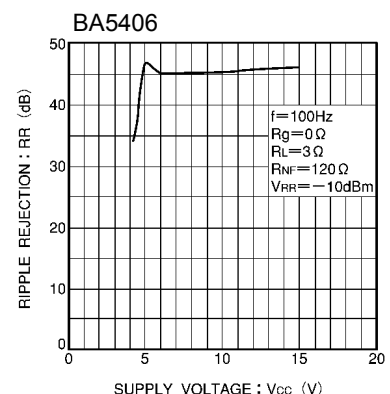
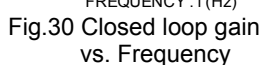
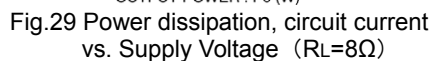
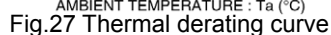
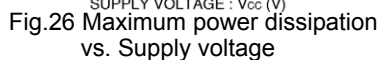
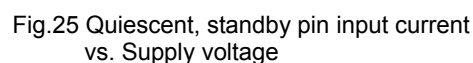
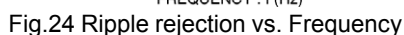
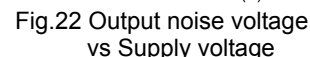
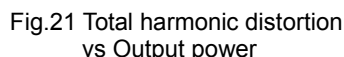


Fig.19 Ripple rejection ratio vs Supply voltage

## BA5417





## BA5417 BTL mode

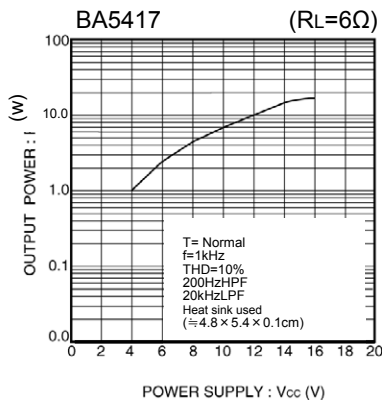


Fig.31 Rated output power vs. Supply Voltage

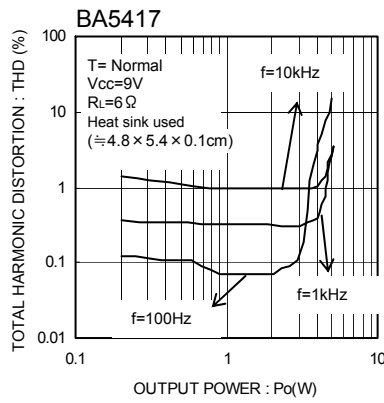


Fig.32 Total harmonic distortion vs. Output power

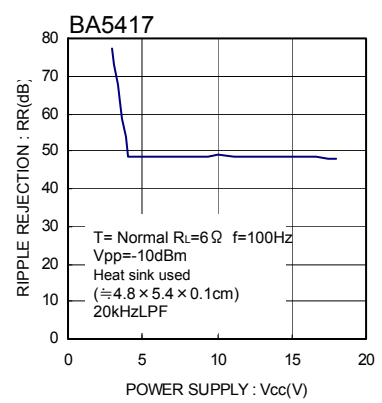


Fig.33 Ripple rejection ratio vs. Supply Voltage

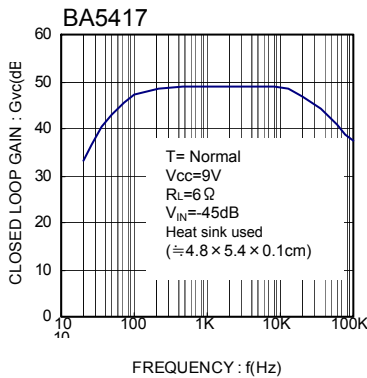


Fig.34 Close loop gain vs. Frequency

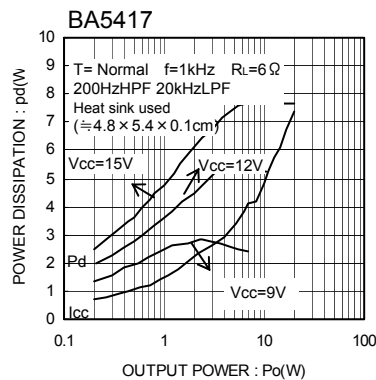


Fig.35 Power dissipation, Supply current vs. Frequency

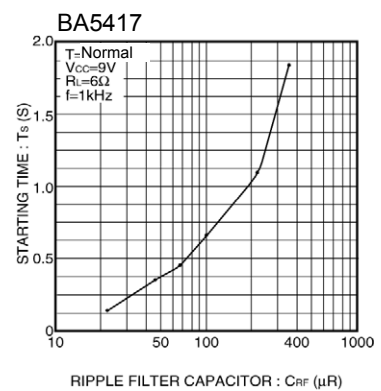


Fig.36 Starting time vs. Ripple filter capacitor

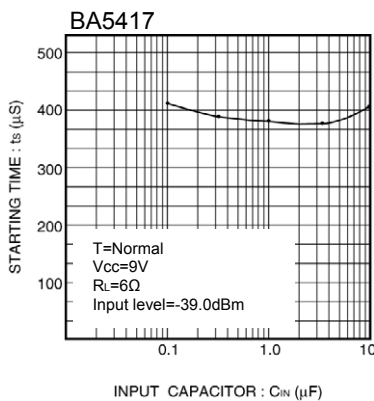


Fig.37 Starting time vs. Input coupling capacitor

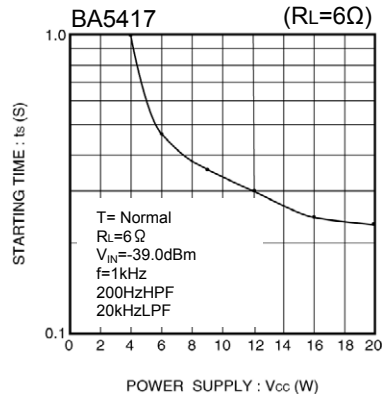


Fig.38 Starting time vs. Supply Voltage

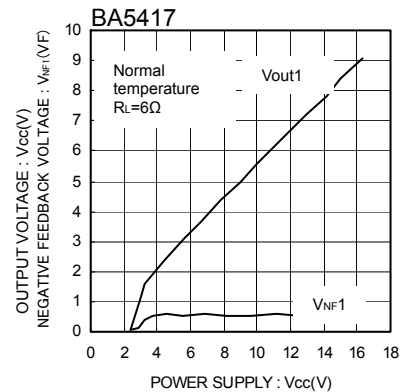


Fig.39 Output voltage, Negative feed back voltage vs. Supply Voltage

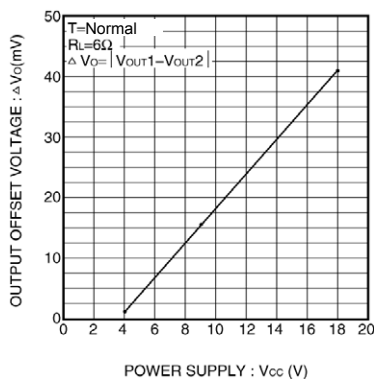


Fig.40 Output offset voltage vs. Supply Voltage

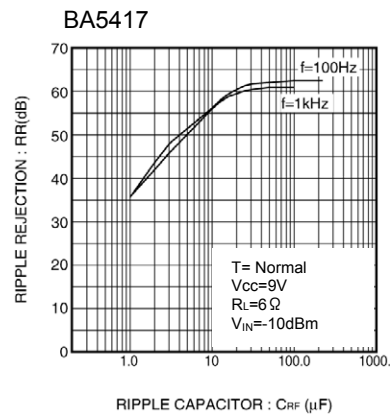


Fig.41 Ripple rejection vs. Ripple filter capacitor

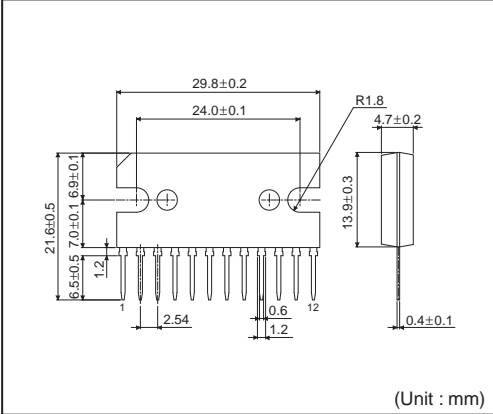
**●Notes for use**

- 1) Numbers and data in entries are representative design values and are not guaranteed values of the items.
- 2) Although ROHM is confident that the example application circuit reflects the best possible recommendations, be sure to verify circuit characteristics for your particular application. Modification of constants for other externally connected circuits may cause variations in both static and transient characteristics for external components as well as this Rohm IC. Allow for sufficient margins when determining circuit constants.
- 3) Absolute maximum ratings  
Use of the IC in excess of absolute maximum ratings, such as the applied voltage or operating temperature range (Topr), may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure, such as a fuse, should be implemented when using the IC at times where the absolute maximum ratings may be exceeded.
- 4) GND potential  
Ensure a minimum GND pin potential in all operating conditions. Make sure that no pins are at a voltage below the GND at any time, regardless of whether it is a transient signal or not.
- 5) Thermal design  
Perform thermal design, in which there are adequate margins, by taking into account the permissible dissipation (Pd) in actual states of use.
- 6) Short circuit between terminals and erroneous mounting  
Pay attention to the assembly direction of the ICs. Wrong mounting direction or shorts between terminals, GND, or other components on the circuits, can damage the IC.
- 7) Operation in strong electromagnetic field  
Using the ICs in a strong electromagnetic field can cause operation malfunction.

●Ordering part number

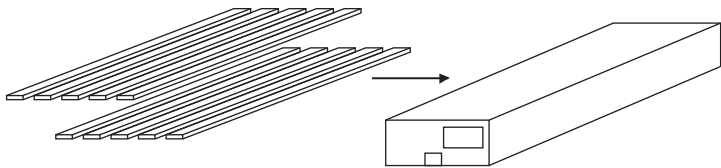
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B	A												
5	4	0	6										
Part No.	Part No. 5406 5417	Package None: SIP-M12 HSIP15	Packaging and forming specification None: Tube										

SIP-M12



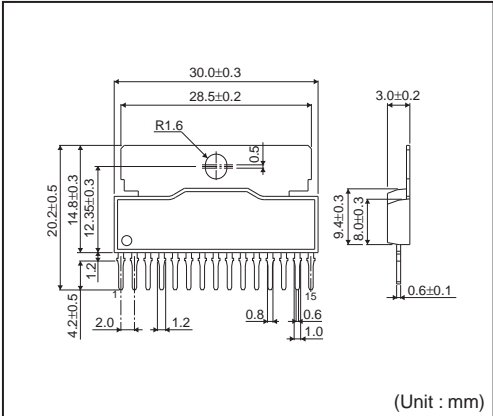
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Quantity	300pcs
Direction of feed	Direction of products is fixed in a container tube



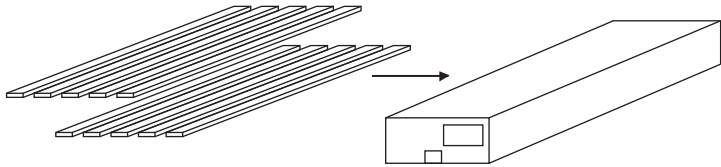
\* Order quantity needs to be multiple of the minimum quantity.

HSIP15



<Tape and Reel information>

Container	Tube
Quantity	300pcs
Direction of feed	Direction of products is fixed in a container tube



\* Order quantity needs to be multiple of the minimum quantity.

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JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

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  - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - Sealing or coating our Products with resin or other coating materials
  - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

## Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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## Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of ionizer, friction prevention and temperature / humidity control).

## Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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